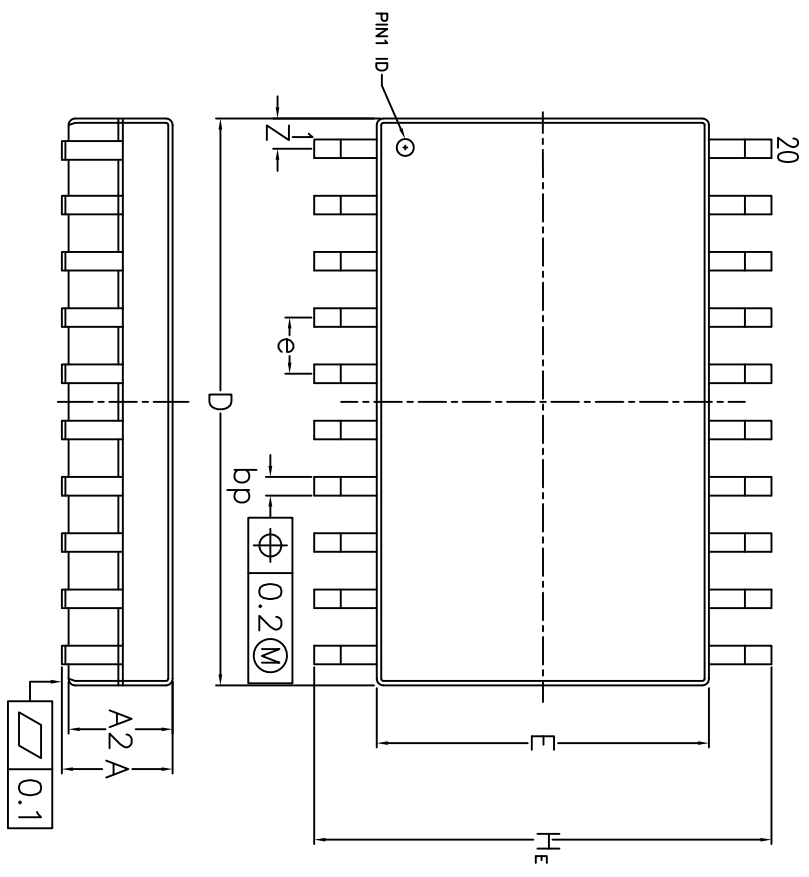
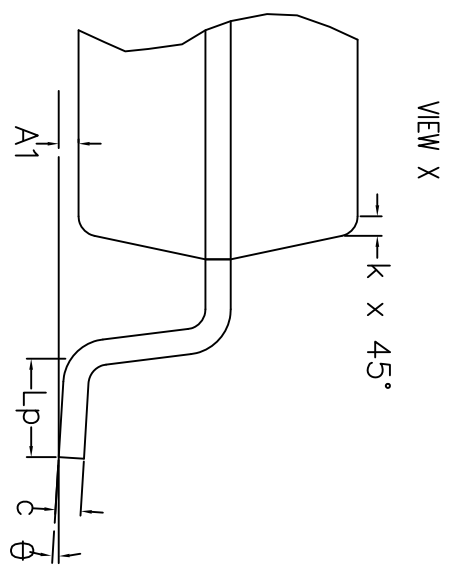


REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	2/25/16	J.H




DIMENSIONS OF SUB-GROUP B1	
A max	2.65
bp min	0.35
bp max	0.49
e nom	1.27
He min	10.00
He max	10.65
Lpmin	0.40
Z max	0.81



DIMENSIONS OF SUB-GROUP C1	
A min	2.35
A1 min	0.10
A1 max	0.30
A2 min	2.25
A2 max	2.45
c min	0.23
c max	0.32
D min*	12.60
D max*	13.00
E min*	7.40
E max*	7.60
k min	0.25
θ max	0°
θ max	8°

- WEIGHT ≤ 0.55 g
- BODY MATERIAL LOW STRESS EPOXY
- LEAD MATERIAL FeNi-ALLOY or Cu-ALLOY
- LEAD FINISH SOLDER PLATING
- LEAD FORM Z-BENDS

* WITHOUT MOLD FLASH

TOLERANCES UNLESS SPECIFIED			
DECIMAL	ANGULAR	6024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 284-8200 FAX: (408) 284-3572	
xxx±	±	www.IDT.com	
xxxx±		APPROVALS DATE	
xxxx±		DRAWN DATE	
CHECKED		TITLE PSG20 PACKAGE OUTLINE	
		300 mil SOP	
SIZE	DRAWING No.	REV	
C	PSC-4007-02	00	
DO NOT SCALE DRAWING		SHEET 1 OF 1	